# 1PS70SB20

# Schottky barrier single diode

**17 December 2012** 

**Product data sheet** 

# 1. General description

Planar Schottky barrier diode with an integrated guard ring for stress protection, encapsulated in a very small SOT323 (SC-70) Surface-Mounted Device (SMD) plastic package.

# 2. Features and benefits

- Low forward voltage
- Low capacitance
- AEC-Q101 qualified

# 3. Applications

- Ultra high-speed switching
- Line termination
- Voltage clamping
- Reverse polarity protection

## 4. Quick reference data

Table 1. Quick reference data

| Symbol         | Parameter       | Conditions                        | Min | Тур | Max | Unit |
|----------------|-----------------|-----------------------------------|-----|-----|-----|------|
| l <sub>F</sub> | forward current |                                   | -   | -   | 500 | mA   |
| $V_R$          | reverse voltage |                                   | -   | -   | 40  | V    |
| V <sub>F</sub> | forward voltage | $I_F$ = 500 mA; $T_{amb}$ = 25 °C | -   | -   | 550 | mV   |

# 5. Pinning information

Table 2. Pinning information

| Tubio 2. | 9      | momuton       |                    |                |
|----------|--------|---------------|--------------------|----------------|
| Pin      | Symbol | Description   | Simplified outline | Graphic symbol |
| 1        | Α      | anode         | 3                  | K              |
| 2        | n.c.   | not connected |                    | A n.c.         |
| 3        | К      | cathode       | 1                  | aaa-005805     |





Schottky barrier single diode

# 6. Ordering information

#### Table 3. Ordering information

| Type number | Package |  |         |  |  |  |
|-------------|---------|--|---------|--|--|--|
|             | Name    | Description                              | Version |  |  |  |
| 1PS70SB20   | SC-70   | plastic surface-mounted package; 3 leads | SOT323  |  |  |  |

# 7. Marking

#### Table 4. Marking codes

| Type number | Marking code [1] |
|-------------|------------------|
| 1PS70SB20   | 7%2              |

<sup>[1] % =</sup> placeholder for manufacturing site code

# 8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol           | Parameter                           | Conditions  | Min | Max | Unit |
|------------------|-------------------------------------|---|-----|-----|------|
| V <sub>R</sub>   | reverse voltage                     |   | -   | 40  | V    |
| l <sub>F</sub>   | forward current                     |   | -   | 500 | mA   |
| I <sub>FSM</sub> | non-repetitive peak forward current | $t_p$ = 8.3 ms; $T_{j(init)}$ = 25 °C; half sine wave | -   | 2   | Α    |
| T <sub>j</sub>   | junction temperature                |   | -   | 125 | °C   |
| T <sub>amb</sub> | ambient temperature                 |   | -55 | 125 | °C   |
| T <sub>stg</sub> | storage temperature                 |   | -65 | 150 | °C   |

## 9. Thermal characteristics

#### Table 6. Thermal characteristics

| Symbol               | Parameter                                   | Conditions  |     | Min | Тур | Max | Unit |
|----------------------|---|-------------|-----|-----|-----|-----|------|
| R <sub>th(j-a)</sub> | thermal resistance from junction to ambient | in free air | [1] | -   | -   | 500 | K/W  |

<sup>[1]</sup> Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

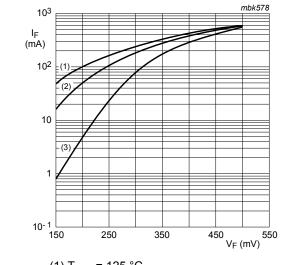
1PS70SB20

## Schottky barrier single diode

# 10. Characteristics

Table 7. Characteristics

| Symbol            | Parameter         | Conditions   | Min | Тур | Max | Unit |
|-------------------|-------------------|--|-----|-----|-----|------|
| V <sub>F</sub>    | forward voltage   | I <sub>F</sub> = 500 mA; T <sub>amb</sub> = 25 °C                      | -   | -   | 550 | mV   |
| I <sub>R</sub> re | reverse current   | V <sub>R</sub> = 35 V; T <sub>amb</sub> = 25 °C                        | -   | -   | 100 | μA   |
|                   |                   | $V_R$ = 35 V; pulsed; $t_p$ = 300 µs; $\delta$ = 0.02 ; $T_j$ = 100 °C | -   | -   | 10  | mA   |
| C <sub>d</sub>    | diode capacitance | V <sub>R</sub> = 0 V; f = 1 MHz; T <sub>amb</sub> = 25 °C              | 60  | -   | 90  | pF   |

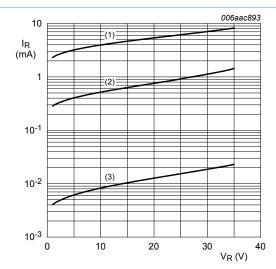




(2) 
$$T_{amb}$$
 = 85 °C

(3) 
$$T_{amb} = 25 \, ^{\circ}C$$

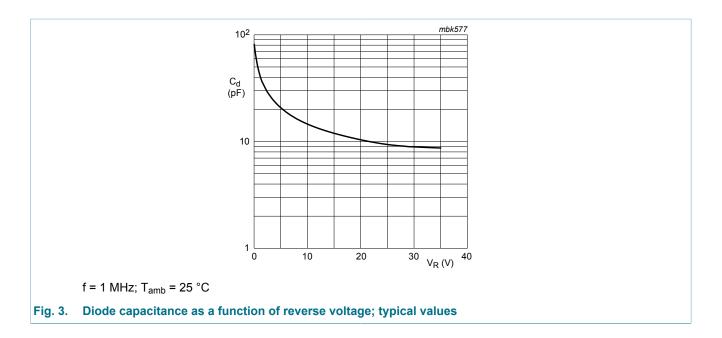
Fig. 1. Forward current as a function of forward voltage; typical values



- (1)  $T_{amb}$  = 125 °C
- (2)  $T_{amb} = 85 \, ^{\circ}C$
- (3)  $T_{amb} = 25 \, ^{\circ}C$

Fig. 2. Reverse current as a function of reverse voltage; typical values

#### Schottky barrier single diode

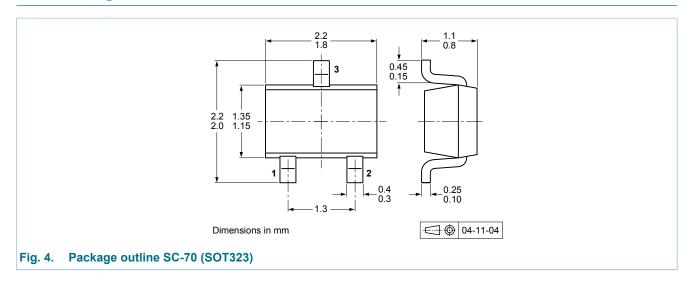


## 11. Test information

## 11.1 Quality information

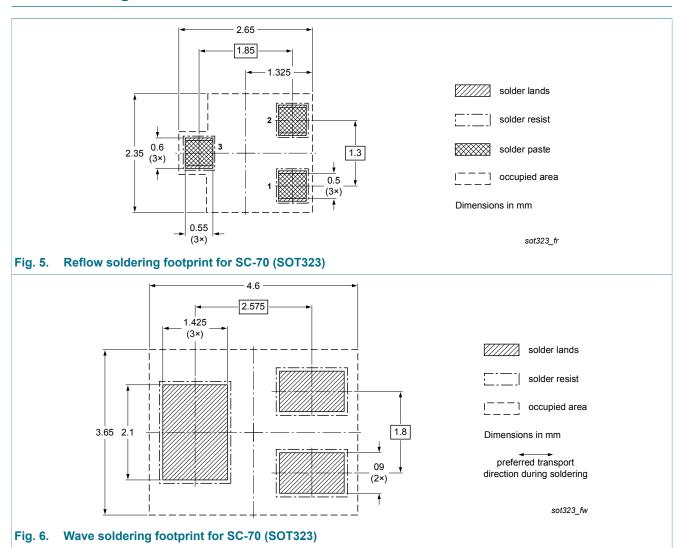
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

# 12. Package outline



## Schottky barrier single diode

# 13. Soldering



# 14. Revision history

Table 8. Revision history

| Data sheet ID | Release date | Data sheet status  | Change notice | Supersedes    |
|---------------|--------------|--------------------|---------------|---------------|
| 1PS70SB20 v.2 | 20121217     | Product data sheet | -             | 1PS70SB20 v.1 |

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# Schottky barrier single diode

| Data sheet ID  | Release date   | Data sheet status   | Change notice                                       | Supersedes |
|----------------|--|---|---|------------|
| Modifications: | of NXP Semicondo Legal texts have be Sections 1 to 3 up Section 4 "Quick re Section 6 "Orderin Section 7 "Marking Table 5 "Limiting verighted Section 11 "Test in Figure 4: supersect Section 13 "Solder | een adapted to the new co<br>dated<br>eference data" added<br>g information" added<br>g" updated<br>alues": ambient temperatu<br>formation" added<br>ded by minimized package | ompany name where app<br>ure T <sub>amb</sub> added |            |
| 1PS70SB20 v.1  | 20010316   | Product data sheet  | -   | -          |

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# 15. Legal information

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| Document status [1][2]               | Product status [3] | Definition  |
|--------------------------------------|--------------------|---|
| Objective<br>[short] data<br>sheet   | Development        | This document contains data from the objective specification for product development. |
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